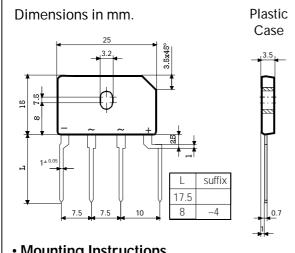
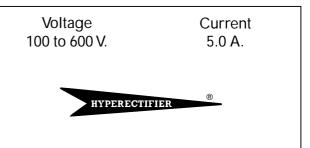


5 Amp. Glass Passivated Bridge Rectifier



- Mounting Instructions
- High temperature soldering guaranteed: 260 °C 10 sc.
- Recommended mounting torque: 8 Kg.cm.



- Glass Passivated Junction Chips.
- UL recognized under component index file number E130180.
- · Lead and polarity identifications.
- · Case: Molded Plastic.
- Ideal for printed circuit board (P.C.B.).
- · High surge current capability.
- The plastic material carries U/L recognition 94 V-O.

Maximum Ratings, according to IEC publication No. 134

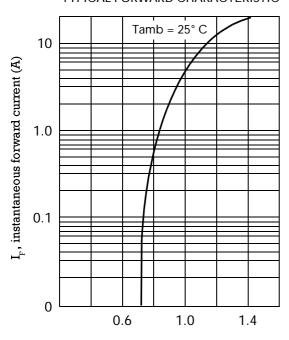
		FBI5.1B 1M1	FBI5.1D 1M1	FBI5.1F 1M1	FBI5.1J 1M1
V_{RRM}	Peak Recurrent Reverse Voltage (V)	100	200	300	600
V_{RMS}	Maximum RMS Voltage (V)	70	140	210	420
V _R	Recommended Input Voltage (V)	40	80	125	250
I _{F(AV)}	Max. Average forward current with heatsink without heatsink	5.0 A at 100 °C 3.0 A at 25 °C			
I _{FRM}	Recurrent peak forward current	30 A			
I _{FSM}	10 ms. peak forward surge current	400 A			
I ² t	I ² t value for fusing (t = 10 ms)	800 A ² sec			
V _{DIS}	Dielectric strength (terminals to case, AC 1 min.)	1500 V			
T _j	Operating temperature range	− 40 to + 150 °C			
T _{stg}	Storage temperature range	- 40 to +150 °C			

Electrical Characteristics at Tamb = 25°C

V _F	Max. forward voltage drop per element at $I_F = 5$ A	1.1 V
I _R	Max. reverse current per element at $V_{\mbox{\tiny RRM}}$	5μΑ
	MAXIMUM THERMAL RESISTANCE	
R _{th (j-c)}	Junction-Case. With Heatsink.	2.2 °C/W
R _{th (i-a)}	Junction-Ambient. Without Heatsink.	22 °C/W

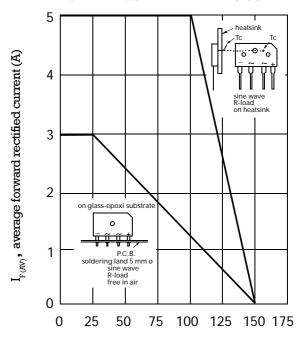


TYPICAL FORWARD CHARACTERISTIC



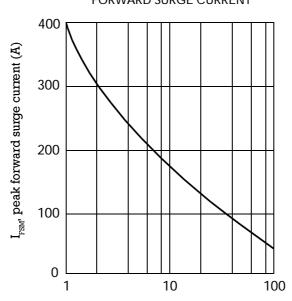
 $V_{_{\rm F}}$, instantaneous forward voltage (V)

FORWARD CURRENT DERATING CURVE



Tamb, ambient temperature (°C)

MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



Number of cycles at 50 Hz.